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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Application of:

Kuo-Lung Lei

Group Art Unit: 2814

Serial No.: 10/600,799

Examiner: Weiss, Howard

Filed: June 18, 2003

In Response to Office Action

Dated: Aug. 4, 2004

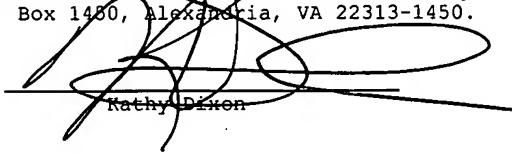
For: MEM Micro-Cap Wafer Level Chip Scale Package

Attorney Docket No.: 68,700-015

Certificate of Mailing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: Aug. 25, 2004

  
Kathy J. Dixon

RESPONSE TO OFFICE ACTION

Commissioner for Patents  
Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action mailed Aug. 4, 2004 of a restriction requirement imposed by the Examiner, the Applicants hereby elect with traverse the prosecution of Group I, claims 1-9 and 12-16.